Non-inverting 3-State Buffer

The NL17SZ126 is a high performance dual noninverting buffer operating from a 2.3 V to 5.5 V supply.

- Extremely High Speed: t_{PD} 2.6 ns (typical) at $V_{CC} = 5 \text{ V}$
- Designed for 2.3 V to 5.5 V V_{CC} Operation
- Over Voltage Tolerant Inputs and Outputs
- $\bullet\,$ LVTTL Compatible Interface Capability With 5 V TTL Logic with V_{CC} = 3 V
- LVCMOS Compatible
- 24 mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current Substantially Reduces System Power Requirements
- 3-State OE Input is Active HIGH
- Replacement for NC7SZ126
- Chip Complexity = 36 Feet

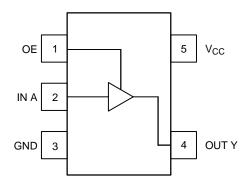


Figure 1. Pinout (Top View)



Figure 2. Logic Symbol



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MARKING DIAGRAMS



SC70-5/SC-88A/SOT-353 DF SUFFIX CASE 419A



d = Date Code

PIN ASSIGNMENT						
1	OE					
2	IN A					
3	GND					
4	OUT Y					
5	V _{CC}					

FUNCTION TABLE

OE Input	A Input	Y Output
Н	L	L
Н	Н	Н
L	X	Z

X = Don't Care

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

MAXIMUM RATINGS

Symbol	Paramete	r	Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +7.0	V
V _{IN}	DC Input Voltage		-0.5 to +7.0	V
V _{OUT}	DC Output Voltage	-0.5 to +7.0	V	
I _{IK}	DC Input Diode Current	-50	mA	
I _{OK}	DC Output Diode Current	-50	mA	
I _{OUT}	DC Output Sink Current	±50	mA	
I _{CC}	DC Supply Current per Supply Pin		±100	mA
T _{STG}	Storage Temperature Range	-65 to +150	°C	
T _L	Lead Temperature, 1 mm from Case for 10 Se	conds	260	°C
T _J	Junction Temperature Under Bias		+150	°C
θ_{JA}	Thermal Resistance	SC-70/SC-88A	350	°C/W
P _D	Power Dissipation in Still Air at 85°C	SC-70/SC-88A	150	mW
MSL	Moisture Sensitivity		Level 1	
F _R	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	
V _{ESD}	ESD Withstand Voltage	Human Body Model (Note 2) Machine Model (Note 3) Charged Device Model (Note 4)	> 2000 > 200 N/A	V

Maximum Ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum–rated conditions is not implied. Functional operation should be restricted to the Recommended Operating Conditions.

- 1. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2-ounce copper trace with no air flow.
- 2. Tested to EIA/JESD22-A114-A.
- 3. Tested to EIA/JESD22-A115-A.
- 4. Tested to JESD22-C101-A.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit	
V _{CC}	DC Supply Voltage		2.0	5.5	V
V _{IN}	DC Input Voltage	0	5.5	V	
V _{OUT}	DC Output Voltage		0	5.5	V
T _A	Operating Temperature Range		-40	+85	°C
t _r , t _f	Input Rise and Fall Time V	$_{CC} = 3.0 \text{ V} \pm 0.3 \text{ V}$ $_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$	0 0	100 20	ns/V

DEVICE JUNCTION TEMPERATURE VERSUS TIME TO 0.1% BOND FAILURES

Junction Temperature °C	Time, Hours	Time, Years
80	1,032,200	117.8
90	419,300	47.9
100	178,700	20.4
110	79,600	9.4
120	37,000	4.2
130	17,800	2.0
140	8,900	1.0

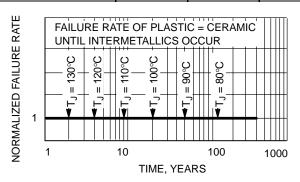


Figure 3. Failure Rate versus Time Junction Temperature

DC ELECTRICAL CHARACTERISTICS

			V _{CC}			;	-40°C ≤		
Symbol	Parameter	Condition	(V)	Min	Тур	Max	Min	Max	Unit
V _{IH}	High-Level Input Voltage		2.3 to 5.5	0.7 V _{CC}			0.7 V _{CC}		V
V _{IL}	Low-Level Input Voltage		2.3 to 5.5			0.3 V _{CC}		0.3 V _{CC}	V
V _{OH}	High-Level Output Voltage V _{IN} = V _{IH}	Voltage $I_{OH} = 100 \mu A$ $I_{OH} = -8 mA$ $I_{OH} = -12 mA$ $I_{OH} = -16 mA$ $I_{OH} = -24 mA$ $I_{OH} = -32 mA$		V _{CC} - 0.1 1.9 2.2 2.4 2.3 3.8	V _{CC} 2.1 2.4 2.7 2.5 4.0		V _{CC} - 0.1 1.9 2.2 2.4 2.3 3.8		V
V _{OL}	Low-Level Output Voltage V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA I _{OL} = 8 mA I _{OL} = 12 mA I _{OL} = 16 mA I _{OL} = 24 mA I _{OL} = 32 mA	2.3 to 5.5 2.3 2.7 3.0 3.0 4.5		0.20 0.22 0.28 0.38 0.42	0.1 0.3 0.4 0.4 0.55 0.55		0.1 0.3 0.4 0.4 0.55 0.55	V
I _{IN}	Input Leakage Current	V _{IN} = V _{CC} or GND	0 to 5.5			±0.1		±1.0	μΑ
I _{OFF}	Power Off–Output Leakage Current	V _{OUT} = 5.5 V	0			1		10	μΑ
I _{CC}	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	5.5			1		10	μΑ
I _{OZ}	3-State Output Leakage	$\begin{array}{c} 0 \text{ V} \leq \text{V}_{OUT} \leq 5.5 \text{ V} \\ \text{VIN} = \text{V}_{IL} \text{ or V}_{IH} \end{array}$	2.3 to 5.5			± 0.5		±5	μΑ

AC ELECTRICAL CHARACTERISTICS ($t_R = t_F = 3.0 \text{ ns}$)

				v _{cc}	Т	A = 25°	С	-40°C ≤	Γ _A ≤ 85°C	
Symbol	Parameter	Conditio	n	(V)	Min	Тур	Max	Min	Max	Unit
t _{PLH}	Propagation Delay AN to YN	$R_L = 1 M\Omega$	C _L = 15 pF	2.5 ± 0.2	1.0		7.5	1.0	8	ns
t _{PHL}	(Figures 4, and 5, Table 1)	R_L = 1 MΩ R_L = 500 Ω	$C_L = 15 pF$ $C_L = 50 pF$	3.3 ± 0.3	0.8 1.2		5.2 5.7	0.8 1.2	5.5 6.0	
		R_L = 1 MΩ R_L = 500 Ω	$C_L = 15 pF$ $C_L = 50 pF$	5.0 ± 0.5	0.5 0.8		4.5 5.0	0.5 0.8	4.8 5.3	
t _{PZH}	Output Enable Time	$R_L = 250 \Omega$	$C_{L} = 50 \text{ pF}$	2.5 ± 0.2	1.8		8.5	1.8	9.0	ns
t _{PZL}	(Figures 6, 7 and 8, Table 1)			3.3 ± 0.3	1.2		6.2	1.2	6.5	
				5.0 ± 0.5	0.8		5.5	0.8	5.8	
t _{PZH}	Output Enable Time	R_L and $R1=500~\Omega$	$C_L = 50 pF$	2.5 ± 0.2	1.5		8.0	1.5	8.5	ns
t _{PZL}	(Figures 6, 7 and 8, Table 1)			3.3 ± 0.3	0.8		5.7	0.8	6.0	
				5.0 ± 0.5	0.3		4.7	0.3	5.0	

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Unit
C _{IN}	Input Capacitance	$V_{CC} = 5.5 \text{ V}, V_I = 0 \text{ V or } V_{CC}$	2.5	pF
C _{OUT}	Output Capacitance	V _{CC} = 5.5 V, V _I = 0 V or V _{CC}	2.5	pF
C _{PD}	Power Dissipation Capacitance (Note 5)	10 MHz, $V_{CC} = 3.3$ V, $V_{I} = 0$ V or V_{CC} 10 MHz, $V_{CC} = 5.5$ V, $V_{I} = 0$ V or V_{CC}	9 11	pF

^{5.} C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: $I_{CC(OPR)} = C_{PD} \bullet V_{CC} \bullet f_{in} + I_{CC} \cdot C_{PD}$ is used to determine the no–load dynamic power consumption; $P_D = C_{PD} \bullet V_{CC}^2 \bullet f_{in} + I_{CC} \bullet V_{CC}$.

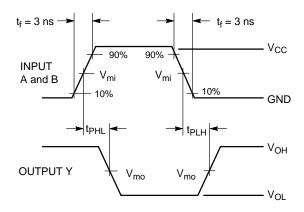
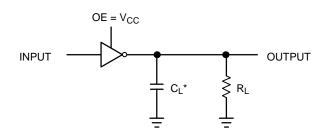
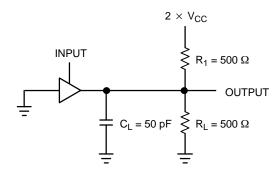


Figure 4. Switching Waveform



*Includes all probe and jig capacitance.
A 1–MHz square input wave is recommended for propagation delay tests.

Figure 5. T_{PLH} or T_{PHL}



A 1–MHz square input wave is recommended for propagation delay tests.

V_{CC} OUTPUT $C_{L} = 50 \text{ pF}$ $R_{L} = 250 \Omega$

A 1–MHz square input wave is recommended for propagation delay tests.

Figure 6. T_{PZL} or T_{PLZ}

Figure 7. T_{PZH} or T_{PHZ}

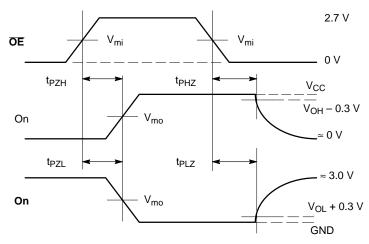


Figure 8. AC Output Enable and Disable Waveform

Table 1. Output Enable and Disable Times

 $t_R = t_F = 2.5 \text{ ns}, 10\% \text{ to } 90\%; f = 1 \text{ MHz}; t_W = 500 \text{ ns}$

	Vcc						
Symbol	3.3 V \pm 0.3 V	2.7 V	2.5 V \pm 0.2 V				
V _{mi}	1.5 V	1.5 V	V _{CC/} 2				
V _{mo}	1.5 V	1.5 V	V _{CC/} 2				

DEVICE ORDERING INFORMATION

			Devi	ce Nomenclat	ture						
Device Order Number	Logic Circuit Indicator	No. of Gates per Package	Temp Range Identifier	Technology	Device Function	Package Suffix	Tape and Reel Suffix	Package Type	Tape and Reel Size		
NL17SZ126	NL	1	7	SZ	126	DF	T2	SC70-5/SC-88A/ SOT-353	178 mm (7"), 3000 Units		

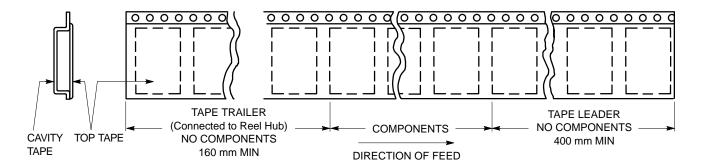


Figure 9. Tape Ends for Finished Goods

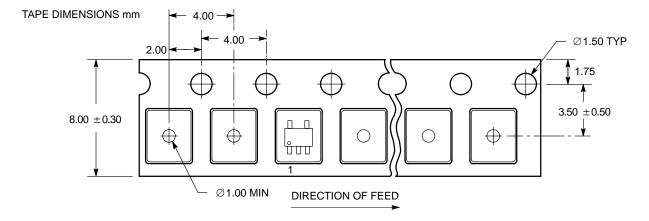


Figure 10. SC-70/SC-88A/SOT-353 DFT2 Reel Configuration/Orientation

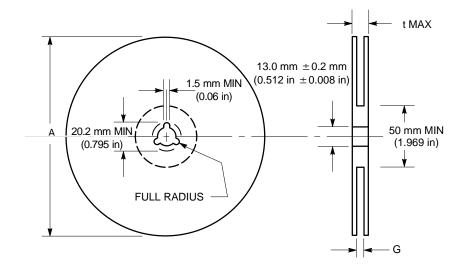


Figure 11. Reel Dimensions

REEL DIMENSIONS

Tape Size	T and R Suffix	A Max	G	t Max
8 mm	T1, T2	178 mm (7")	8.4 mm, + 1.5 mm, -0.0 (0.33 in + 0.059 in, -0.00)	14.4 mm (0.56 in)

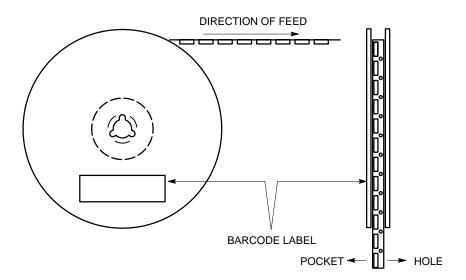
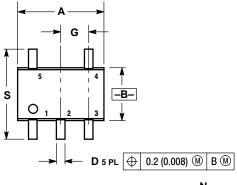


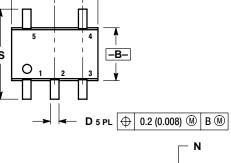
Figure 12. Reel Winding Direction

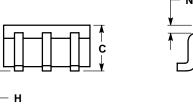
PACKAGE DIMENSIONS

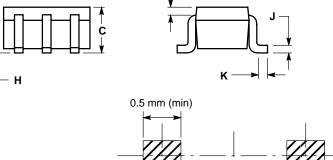
SC70-5/SC-88A/SOT-353 **DF SUFFIX**

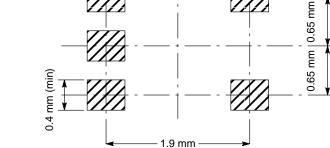
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NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI

3. 419A-01 OBSOLETE. NEW STANDARD 419A-02.

MILLIMETERS

1.15 1.35

0.80 1.10

0.10 0.25

0.10

0.65 BSC

0.20 REF 2.00

0.10

CONTROLLING DIMENSION: INCH.

INCHES MIN MAX 0.071 0.087 B 0.045 0.053

0.031 0.043

0.004 0.012 0.026 BSC

--- 0.004 0.004 0.010

0.004 0.012

N 0.008 REF S 0.079 0.087

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